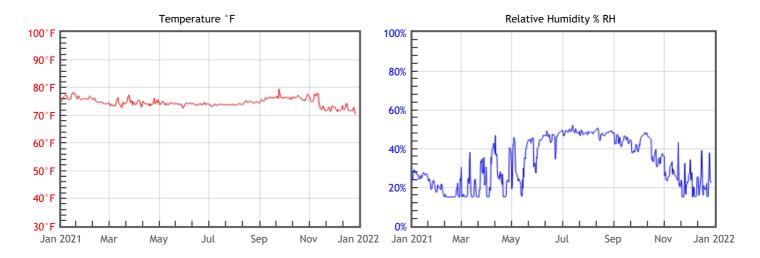
# 4 East (LC PA-PZ)

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## **Preservation Environment Evaluation**

Type of Decay	Risks & Metrics	Evaluation & General Comments
Natural Aging Chemical decay of organic materials	RISK TWPI = 41	Accelerated rate of chemical decay in all organic materials due to the cumulative effects of temperature and humidity, with especially high risk for fast decaying organic materials such as acidic paper, color photographs and cellulosic plastics.
Mechanical Damage Physical damage to hygroscopic materials	RISK  % DC = 1.44 % EMC min = 3.9 % EMC max = 9	Heightened risk of physical damage to any hygroscopic material, such as paintings, rare books, furniture, paper, leather, film, or color photos, due to extremely low or high levels of humidity, and / or excessive humidity fluctuation.
Mold Risk  Mold growth in area or on collection objects	GOOD  MRF = 0	Minimal risk of mold growth.
Metal Corrosion Corrosion of metal components or objects	OK % EMC max = 9	Generally OK, but archeological or salt-encrusted metals may corrode due to extended periods of moderately high levels of humidity.

# **Graphs**



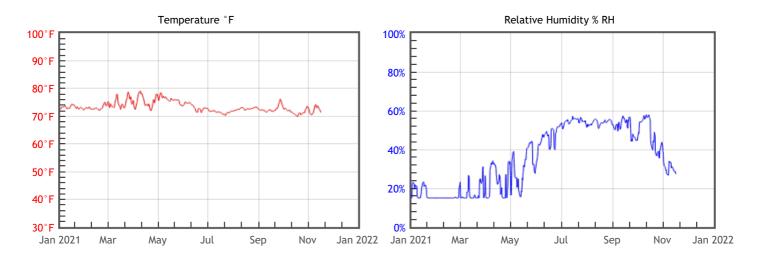
Temperature		Relative H	Relative Humidity		Dew Point	
T°F Mean	74.7	%RH Mean	33	DP°F Mean	42	
T°F Median	74.4	%RH Median	34	DP°F Median	45.1	
T°F Stdev	1.5	%RH Stdev	12	DP°F Stdev	11.1	
T°F Min	70.2	%RH Min	15	DP°F Min	21.1	
T°F Max	79.4	%RH Max	61	DP°F Max	60.6	
I F MAX	79.4	%KH Max	61	DP F MAX	60.	

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### **Preservation Environment Evaluation**

Type of Decay	Risks & Metrics	Evaluation & General Comments
Natural Aging Chemical decay of organic materials	RISK TWPI = 42	Accelerated rate of chemical decay in all organic materials due to the cumulative effects of temperature and humidity, with especially high risk for fast decaying organic materials such as acidic paper, color photographs and cellulosic plastics.
Mechanical Damage Physical damage to hygroscopic materials	RISK  % DC = 1.83 % EMC min = 3.5 % EMC max = 10	Heightened risk of physical damage to any hygroscopic material, such as paintings, rare books, furniture, paper, leather, film, or color photos, due to extremely low or high levels of humidity, and / or excessive humidity fluctuation.
Mold Risk  Mold growth in area or on collection objects	GOOD  MRF = 0	Minimal risk of mold growth.
Metal Corrosion Corrosion of metal components or objects	OK % EMC max = 10	Generally OK, but archeological or salt-encrusted metals may corrode due to extended periods of moderately high levels of humidity.

# Graphs



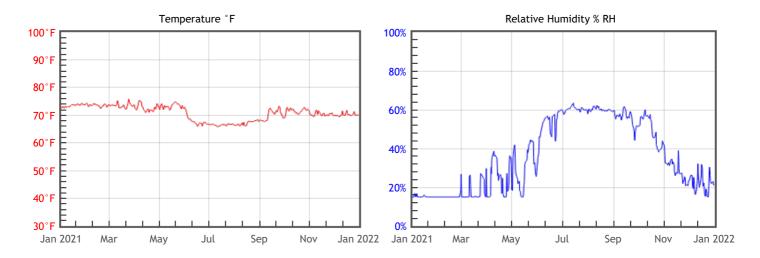
Temperature		Relative Humidity		Dew P	Dew Point	
T°F Mean	73.4	%RH Mean	36	DP°F Mean	41.9	
T°F Median	72.9	%RH Median	37	DP°F Median	46	
T°F Stdev	1.9	%RH Stdev	16	DP°F Stdev	12.8	
T°F Min	69.7	%RH Min	15	DP°F Min	21.6	
T°F Max	79.2	%RH Max	63	DP°F Max	58.7	

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### **Preservation Environment Evaluation**

Type of Decay	Risks & Metrics	Evaluation & General Comments
Natural Aging Chemical decay of organic materials	OK TWPI = 50	Generally OK, but fast decaying organic materials such as acidic paper, color photographs and cellulosic plastics will be at elevated risk due to the cumulative effects of temperature and humidity
Mechanical Damage Physical damage to hygroscopic materials	RISK  % DC = 2.15 % EMC min = 3.5 % EMC max = 11.2	Heightened risk of physical damage to any hygroscopic material, such as paintings, rare books, furniture, paper, leather, film, or color photos, due to extremely low or high levels of humidity, and / or excessive humidity fluctuation.
Mold Risk Mold growth in area or on collection objects	GOOD  MRF = 0	Minimal risk of mold growth.
Metal Corrosion Corrosion of metal components or objects	RISK  % EMC max = 11.2	Heightened risk of metal corrosion due to extended periods of high levels of humidity.

## Graphs



Temperature		Relative H	Relative Humidity		Dew Point	
T°F Mean	70.8	%RH Mean	36	DP°F Mean	39.4	
T°F Median	71.4	%RH Median	33	DP°F Median	41.8	
T°F Stdev	2.7	%RH Stdev	18	DP°F Stdev	12.7	
T°F Min	65.7	%RH Min	15	DP°F Min	19.7	
T°F Max	76	%RH Max	70	DP°F Max	59.5	

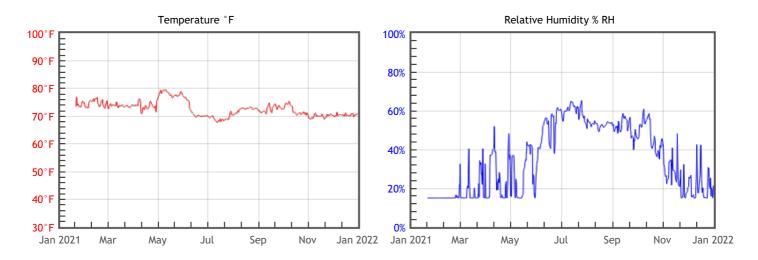
# WG16 (LC HC-LT; Q-RB)

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### **Preservation Environment Evaluation**

Type of Decay	Risks & Metrics	Evaluation & General Comments
Natural Aging Chemical decay of organic materials	RISK TWPI = 44	Accelerated rate of chemical decay in all organic materials due to the cumulative effects of temperature and humidity, with especially high risk for fast decaying organic materials such as acidic paper, color photographs and cellulosic plastics.
Mechanical Damage Physical damage to hygroscopic materials	RISK  % DC = 2.15 % EMC min = 3.5 % EMC max = 11.2	Heightened risk of physical damage to any hygroscopic material, such as paintings, rare books, furniture, paper, leather, film, or color photos, due to extremely low or high levels of humidity, and / or excessive humidity fluctuation.
Mold Risk  Mold growth in area or on collection objects	GOOD  MRF = 0	Minimal risk of mold growth.
Metal Corrosion Corrosion of metal components or objects	RISK  % EMC max = 11.2	Heightened risk of metal corrosion due to extended periods of high levels of humidity.

# **Graphs**



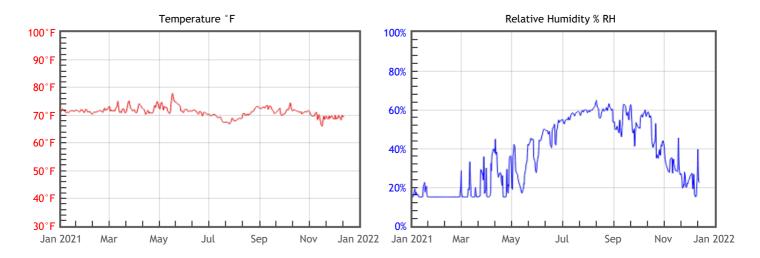
Temperature		Relative Humidity		Dew P	Dew Point	
T°F Mean	72.7	%RH Mean	36	DP°F Mean	40.8	
T°F Median	72.6	%RH Median	36	DP°F Median	44.6	
T°F Stdev	2.7	%RH Stdev	17	DP°F Stdev	13.3	
T°F Min	67.4	%RH Min	15	DP°F Min	19.6	
T°F Max	79.6	%RH Max	75	DP°F Max	62.4	

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### **Preservation Environment Evaluation**

Type of Decay	Risks & Metrics	Evaluation & General Comments
Natural Aging Chemical decay of organic materials	OK TWPI = 47	Generally OK, but fast decaying organic materials such as acidic paper, color photographs and cellulosic plastics will be at elevated risk due to the cumulative effects of temperature and humidity
Mechanical Damage Physical damage to hygroscopic materials	RISK  % DC = 2.08 % EMC min = 3.5 % EMC max = 11	Heightened risk of physical damage to any hygroscopic material, such as paintings, rare books, furniture, paper, leather, film, or color photos, due to extremely low or high levels of humidity, and / or excessive humidity fluctuation.
Mold Risk Mold growth in area or on collection objects	GOOD MRF = 0	Minimal risk of mold growth.
Metal Corrosion Corrosion of metal components or objects	RISK  % EMC max = 11	Heightened risk of metal corrosion due to extended periods of high levels of humidity.

## Graphs



Temperature		Relative H	Relative Humidity		Point
T°F Mean	71.2	%RH Mean	36	DP°F Mean	40.1
T°F Median	71.3	%RH Median	35	DP°F Median	43.3
T°F Stdev	1.7	%RH Stdev	17	DP°F Stdev	13.5
T°F Min	65.8	%RH Min	15	DP°F Min	18.3
T°F Max	78	%RH Max	67	DP°F Max	60.7